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Ceramic Capacitor Applications Guide Soldering and Solderability Maintenance of Leaded Electronic Components

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APPLICATIONS GUIDE
SOLDERING AND SOLDERABILITY MAINTENANCE
OF LEADED ELECTRONIC COMPONENTS

TABLE OF CONTENTS

Paragraph	Page
1.0 BACKGROUND AND PURPOSE	1
2.0 HAND AND WAVE SOLDERING	1
3.0 CLEANING AND RETINNING OF OXIDIZED TERMINATIONS	4
4.0 PACKAGING AND STORAGE	4